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October 2013

# FDP16AN08A0

# N-Channel PowerTrench<sup>®</sup> MOSFET 75 V, 58 A, 16 m $\Omega$

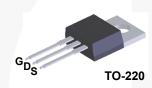
### **Features**

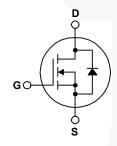
- $R_{DS(on)}$  = 13 m $\Omega$  ( Typ.) @  $V_{GS}$  = 10 V,  $I_D$  = 58 A
- $Q_{G(tot)}$  = 28 nC ( Typ.) @  $V_{GS}$  = 10 V
- · Low Miller Charge
- Low Q<sub>rr</sub> Body Diode
- UIS Capability (Single Pulse and Repetitive Pulse)

Formerly developmental type 82660

### **Applications**

- Synchronous Rectification for ATX / Server / Telecom PSU
- · Battery Protection Circuit
- Motor Drives and Uninterruptible Power Supplies





## MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

| Symbol                            | Parameter  | FDP16AN08A0 | Unit |  |
|-----------------------------------|--|-------------|------|--|
| V <sub>DSS</sub>                  | Drain to Source Voltage  | 75          | V    |  |
| V <sub>GS</sub>                   | Gate to Source Voltage   | ±20         | V    |  |
|                                   | Drain Current  |             |      |  |
|                                   | Continuous ( $T_C = 25^{\circ}C$ , $V_{GS} = 10V$ )  | 58          | Α    |  |
| $I_D$                             | Continuous (T <sub>C</sub> = 100°C, V <sub>GS</sub> = 10V)                                     | 44          |      |  |
|                                   | Continuous ( $T_{amb} = 25^{\circ}C$ , $V_{GS} = 10V$ , with $R_{\theta JA} = 43^{\circ}C/W$ ) |             | Α    |  |
|                                   | Pulsed   | Figure 4    | Α    |  |
| E <sub>AS</sub>                   | Single Pulse Avalanche Energy (Note 1)   | 117         | mJ   |  |
|                                   | Power dissipation  | 135         | W    |  |
| $P_{D}$                           | Derate above 25°C  | 0.9         | W/°C |  |
| T <sub>J</sub> , T <sub>STG</sub> | Operating and Storage Temperature -55 to 175 °C  |             |      |  |

### **Thermal Characteristics**

| $R_{\theta JC}$ | Thermal Resistance Junction to Case, Max.             | 1.11 | °C/W |
|-----------------|---|------|------|
| $R_{\theta JA}$ | Thermal Resistance Junction to Ambient (Note 2), Max. | 62   | °C/W |

| Package Marking | and Orde | ring Information |
|-----------------|----------|------------------|
|-----------------|----------|------------------|

| Device Marking | Device      | Package | Reel Size | Tape Width | Quantity |
|----------------|-------------|---------|-----------|------------|----------|
| FDP16AN08A0    | FDP16AN08A0 | TO-220  | Tube      | N/A        | 50 units |

# **Electrical Characteristics** $T_C = 25^{\circ}C$ unless otherwise noted

| Symbol            | Parameter                         | Test Conditions           |                                  | Min | Тур | Max  | Unit |
|-------------------|-----------------------------------|---------------------------|----------------------------------|-----|-----|------|------|
| Off Char          | acteristics                       |                           |                                  | •   | •   |      |      |
| B <sub>VDSS</sub> | Drain to Source Breakdown Voltage | $I_D = 250 \mu A, V_{GS}$ | S = 0V                           | 75  | -   | -    | V    |
| 1                 | Zero Gate Voltage Drain Current   | V <sub>DS</sub> = 60V     |                                  | -   | -   | 1    |      |
| IDSS              | Zero Gate voltage Diam Current    | $V_{GS} = 0V$             | $T_{\rm C} = 150^{\rm o}{\rm C}$ | -   | -   | 250  | μΑ   |
| I <sub>GSS</sub>  | Gate to Source Leakage Current    | $V_{GS} = \pm 20V$        |                                  | -   | -   | ±100 | nA   |

### On Characteristics

| V <sub>GS(TH)</sub>            | Gate to Source Threshold Voltage            | $V_{GS} = V_{DS}, I_{D} = 250 \mu A$         | 2     | -     | 4     | V  |
|--------------------------------|---|--|-------|-------|-------|----|
| Desire to Oceano On Desiretore | I <sub>D</sub> = 58A, V <sub>GS</sub> = 10V | -  | 0.013 | 0.016 |       |    |
|                                | I <sub>D</sub> = 29A, V <sub>GS</sub> = 6V  | -  | 0.019 | 0.029 | 0     |    |
| r <sub>DS(ON)</sub>            |   | $I_D = 58A, V_{GS} = 10V,$<br>$T_J = 175$ °C | -     | 0.032 | 0.037 | 32 |

### **Dynamic Characteristics**

| C <sub>ISS</sub>                    | Input Capacitance                | \\ - 25\\ \\ - 0\\                          | - | 1857 | -  | pF |
|-------------------------------------|----------------------------------|---|---|------|----|----|
| Coss                                | Output Capacitance               | $V_{DS} = 25V, V_{GS} = 0V,$<br>f = 1MHz    | - | 288  | -  | pF |
| C <sub>RSS</sub>                    | Reverse Transfer Capacitance     | 1 11411 12                                  | - | 88   | -  | pF |
| $Q_{g(TOT)}$                        | Total Gate Charge at 10V         | V <sub>GS</sub> = 0V to 10V                 |   | 28   | 42 | nC |
| $Q_{g(TH)}$                         | Threshold Gate Charge            | $V_{GS} = 0V \text{ to } 2V$ $V_{DD} = 40V$ | - | 3.5  | 5  | nC |
|                                     | Gate to Source Gate Charge       | I <sub>D</sub> = 58A                        | - | 11   | -  | nC |
| Q <sub>gs</sub><br>Q <sub>gs2</sub> | Gate Charge Threshold to Plateau | I <sub>g</sub> = 1.0mA                      | - | 7.6  | -  | nC |
| $Q_{gd}$                            | Gate to Drain "Miller" Charge    |   | - | 6.4  | -  | nC |

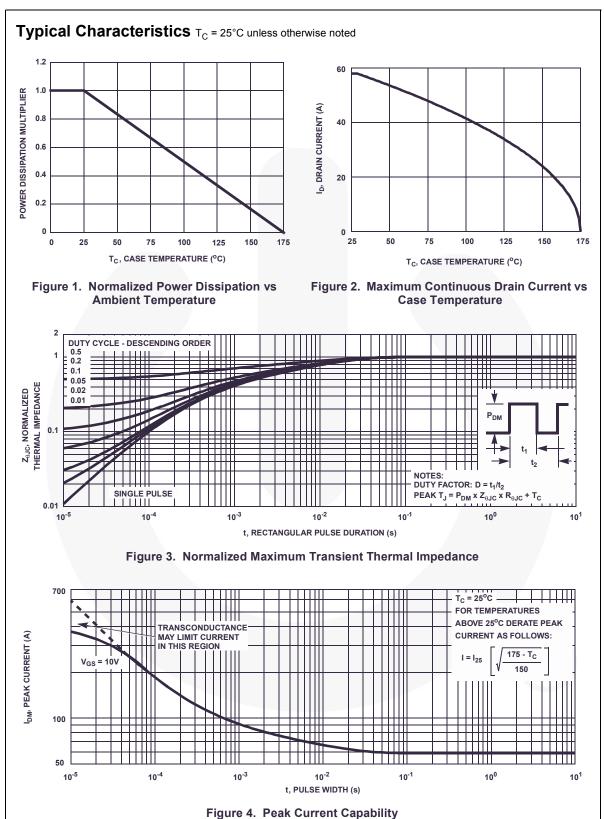
# Switching Characteristics ( $V_{GS} = 10V$ )

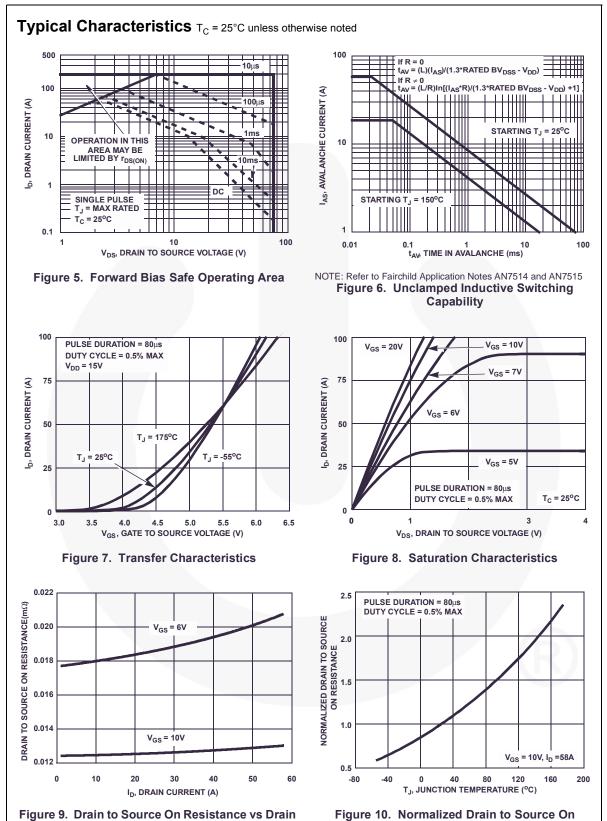
| t <sub>ON</sub>     | Turn-On Time        |   | -/ | -  | 135 | ns |
|---------------------|---------------------|---|----|----|-----|----|
| t <sub>d(ON)</sub>  | Turn-On Delay Time  |   | -  | 8  | -   | ns |
| t <sub>r</sub>      | Rise Time           | V <sub>DD</sub> = 40V, I <sub>D</sub> = 58A | -  | 82 | -   | ns |
| t <sub>d(OFF)</sub> | Turn-Off Delay Time | $V_{GS} = 10V$ , $R_{GS} = 10\Omega$        | -  | 28 | -   | ns |
| t <sub>f</sub>      | Fall Time           |   | -  | 30 | / - | ns |
| t <sub>OFF</sub>    | Turn-Off Time       |   | -  | ,  | 86  | ns |

### **Drain-Source Diode Characteristics**

| V <sub>SD</sub> | Source to Drain Diode Voltage | I <sub>SD</sub> = 58A                      | - | - | 1.25 | V  |
|-----------------|-------------------------------|--|---|---|------|----|
|                 | Source to Drain blode voltage | I <sub>SD</sub> = 29A                      | - | - | 1.0  | V  |
| t <sub>rr</sub> | Reverse Recovery Time         | $I_{SD} = 58A$ , $dI_{SD}/dt = 100A/\mu s$ | - | - | 35   | ns |
| Q <sub>RR</sub> | Reverse Recovered Charge      | $I_{SD} = 58A$ , $dI_{SD}/dt = 100A/\mu s$ | - | - | 36   | nC |

**Notes:** 1: Starting  $T_J = 25^{\circ}C$ ,  $L = 260 \mu H$ ,  $I_{AS} = 30 A$ .





Current

Resistance vs Junction Temperature

# Typical Characteristics T<sub>C</sub> = 25°C unless otherwise noted

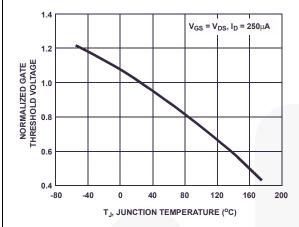


Figure 11. Normalized Gate Threshold Voltage vs Junction Temperature

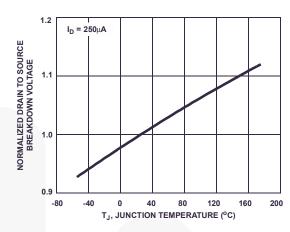


Figure 12. Normalized Drain to Source Breakdown Voltage vs Junction Temperature

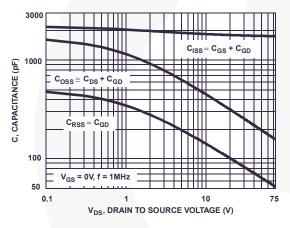


Figure 13. Capacitance vs Drain to Source Voltage

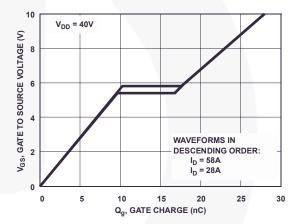


Figure 14. Gate Charge Waveforms for Constant Gate Current

# **Test Circuits and Waveforms**

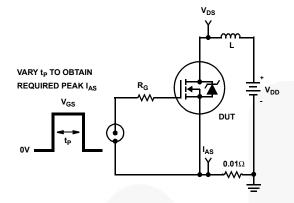


Figure 15. Unclamped Energy Test Circuit

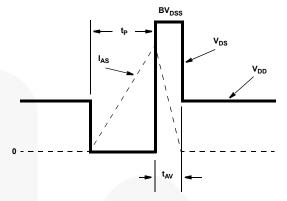


Figure 16. Unclamped Energy Waveforms

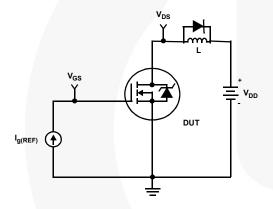


Figure 17. Gate Charge Test Circuit

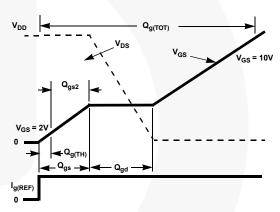


Figure 18. Gate Charge Waveforms

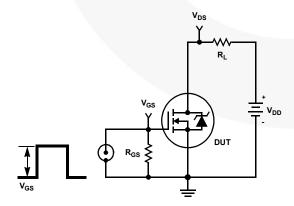


Figure 19. Switching Time Test Circuit

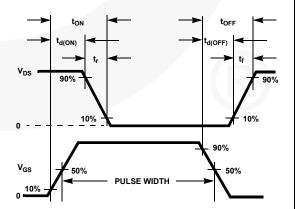
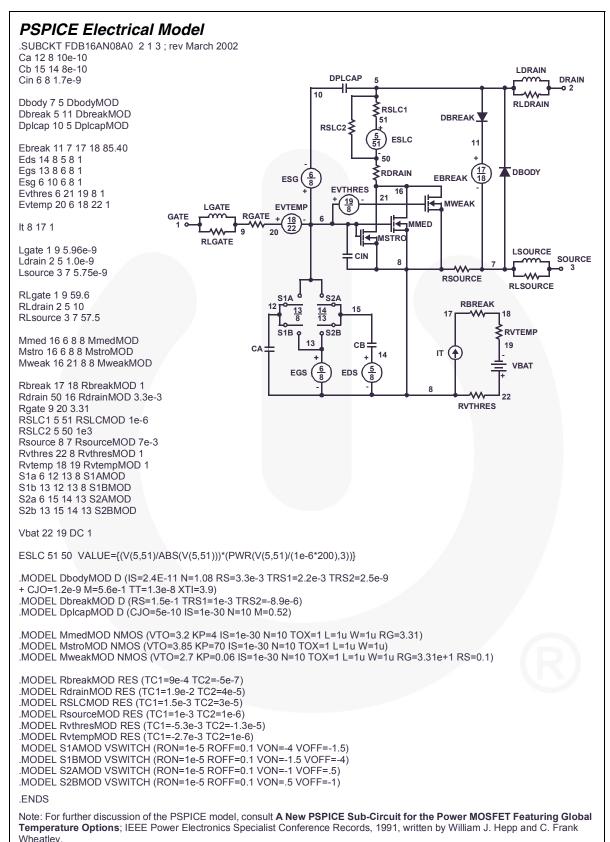


Figure 20. Switching Time Waveforms



### SABER Electrical Model rev March 2002 template FDB16AN08A0 n2,n1,n3 electrical n2,n1,n3 var i iscl dp..model dbodymod = (isl=2.4e-11,nl=1.08,rs=3.3e-3,trs1=2.2e-3,trs2=2.5e-9,cjo=1.2e-9,m=5.6e-1,tt=1.3e-8,xti=3.9) dp..model dbreakmod = (rs=1.5e-1,trs1=1e-3,trs2=-8.9e-6) dp..model dplcapmod = (cjo=5e-10,isl=10e-30,nl=10,m=0.52) m..model mmedmod = (type=\_n,vto=3.2,kp=4,is=1e-30, tox=1) m..model mstrongmod = (type=\_n,vto=3.85,kp=70,is=1e-30, tox=1) m..model mweakmod = (type=\_n,vto=2.7,kp=0.06,is=1e-30, tox=1,rs=0.1) IDRAIN sw\_vcsp..model s1amod = (ron=1e-5,roff=0.1,von=-4,voff=-1.5) DPLCAP DRAIN sw\_vcsp..model s1bmod = (ron=1e-5,roff=0.1,von=-1.5,voff=-4) 10 sw\_vcsp..model s2amod = (ron=1e-5,roff=0.1,von=-1,voff=.5) RLDRAIN sw\_vcsp..model s2bmod = (ron=1e-5,roff=0.1,von=.5,voff=-1) ₹RSLC1 c.ca n12 n8 = 10e-1051 RSLC2 ₹ c.cb n15 n14 = 8e-10 ISCL c.cin n6 n8 = 1.7e-9**DBREAK** 50 dp.dbody n7 n5 = model=dbodymod RDRAIN dp.dbreak n5 n11 = model=dbreakmod 8 **ESG** dp.dplcap n10 n5 = model=dplcapmod DRODY **EVTHRES** 21 MWFAK spe.ebreak n11 n7 n17 n18 = 85.40 <sub>GATE</sub> LGATE EVTEMP **RGATE** MMED spe.eds n14 n8 n5 n8 = 1 **EBREA** Ιg 20 spe.egs n13 n8 n6 n8 = 1 MSTR RLGATE spe.esg n6 n10 n6 n8 = 1 **LSOURCE** spe.evthres n6 n21 n19 n8 = 1 CIN SOURCE spe.evtemp n20 n6 n18 n22 = 1 RSOURCE RLSOURCE i.it n8 n17 = 1**RBREAK** I.lgate n1 n9 = 5.96e-917 I.Idrain n2 n5 = 1.0e-9RVTEMP I.Isource n3 n7 = 5.75e-9CB 19 CA IT 14 res.rlgate n1 n9 = 59.6 **VBAT** res.rldrain n2 n5 = 10 EGS FDS res.rlsource n3 n7 = 57.5 m.mmed n16 n6 n8 n8 = model=mmedmod, l=1u, w=1u **RVTHRES** m.mstrong n16 n6 n8 n8 = model=mstrongmod, l=1u, w=1u m.mweak n16 n21 n8 n8 = model=mweakmod, l=1u, w=1u res.rbreak n17 n18 = 1, tc1=9e-4,tc2=-5e-7 res.rdrain n50 n16 = 3.3e-3, tc1=1.9e-2,tc2=4e-5 res.rgate n9 n20 = 3.31 res.rslc1 n5 n51 = 1e-6, tc1=1.5e-3,tc2=3e-5 res.rslc2 n5 n50 = 1e3 res.rsource n8 n7 = 7e-3, tc1=1e-3,tc2=1e-6 res.rvthres n22 n8 = 1, tc1=-5.3e-3,tc2=-1.3e-5 res.rvtemp n18 n19 = 1, tc1=-2.7e-3,tc2=1e-6 sw\_vcsp.s1a n6 n12 n13 n8 = model=s1amod sw\_vcsp.s1b n13 n12 n13 n8 = model=s1bmod sw\_vcsp.s2a n6 n15 n14 n13 = model=s2amod sw\_vcsp.s2b n13 n15 n14 n13 = model=s2bmod v.vbat n22 n19 = dc=1 equations { i (n51->n50) +=iscl iscl: v(n51,n50) = ((v(n5,n51)/(1e-9+abs(v(n5,n51))))\*((abs(v(n5,n51)\*1e6/200))\*\*3))

## SPICE Thermal Model JUNCTION REV 23 March 2002 FDB16AN08A0T CTHERM1 th 6 0.002 CTHERM2 6 5 0.004 CTHERM3 5 4 0.006 RTHERM1 CTHERM1 CTHERM4 4 3 0.01 CTHERM5 3 2 0.03 CTHERM6 2 tl 0.08 6 RTHERM1 th 6 0.075 RTHERM2 6 5 0.09 RTHERM3 5 4 0.1 RTHERM2 CTHERM2 RTHERM4 4 3 0.15 RTHERM5 3 2 0.2 RTHERM6 2 tl 0.25 5 SABER Thermal Model SABER thermal model FDD16AN08A0T RTHERM3 CTHERM3 template thermal\_model th tl thermal\_c th, tl ctherm.ctherm1 th 6 = 0.002ctherm.ctherm2 6.5 = 0.004ctherm.ctherm354 = 0.006ctherm.ctherm4 4 3 = 0.01ctherm.ctherm5 3 2 = 0.03RTHERM4 CTHERM4 ctherm.ctherm6 2 tl = 0.08 rtherm.rtherm1 th 6 = 0.075rtherm.rtherm2 6.5 = 0.093 rtherm.rtherm354 = 0.1rtherm.rtherm443 = 0.15rtherm.rtherm5 3 2 = 0.2RTHERM5 CTHERM5 rtherm.rtherm6 2 tI = 0.252 RTHERM6 CTHERM6 CASE

### **Mechanical Dimensions**

# TO-220 3L

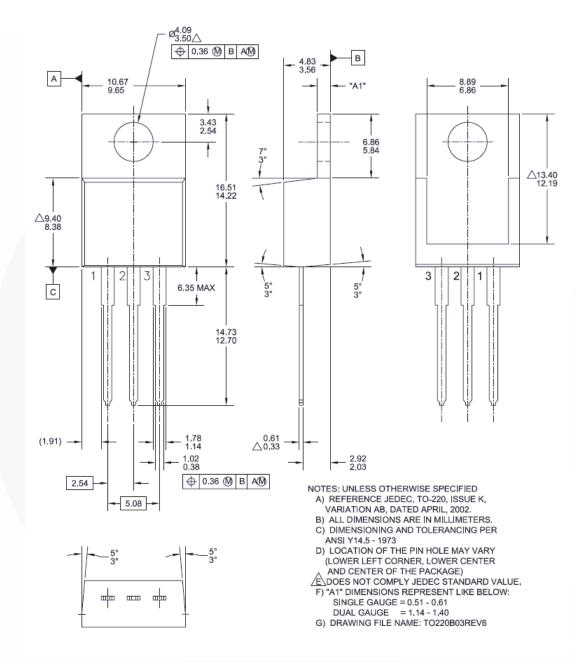


Figure 21. TO-220, Molded, 3Lead, Jedec Variation AB

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Dimension in Millimeters





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